

ABSOLUTE MAXIMUM RATINGS

Drain-Source voltage, V_{DS}	10.6V
Gate-Source voltage, V_{GS}	10.6V
Power dissipation	500 mW
Operating temperature range PA, SA, PC, SC package	0°C to +70°C
Storage temperature range	-65°C to +150°C
Lead temperature, 10 seconds	+260°C

OPERATING ELECTRICAL CHARACTERISTICS

$V_+ = +5V$ (or open) $V_- = GND$ $T_A = 25^\circ C$ unless otherwise specified

CAUTION: ESD Sensitive Device. Use static control procedures in ESD controlled environment.

Parameter	Symbol	ALD110802 / ALD110902			Unit	Test Conditions
		Min	Typ	Max		
Gate Threshold Voltage	$V_{GS(th)}$	0.18	0.20	0.22	V	$I_{DS} = 1\mu A$ $V_{DS} = 0.1V$
Offset Voltage $V_{GS(th)1}-V_{GS(th)2}$	V_{OS}		2	10	mV	
Offset VoltageTempco	$TC \Delta V_{OS}$		5		$\mu V/^\circ C$	$V_{DS1} = V_{DS2}$
GateThreshold Voltage Tempco	$TC\Delta V_{GS(th)}$		-1.7 0.0 +1.6		$mV/^\circ C$	$I_D = 1\mu A$ $I_D = 20\mu A, V_{DS} = 0.1V$ $I_D = 40\mu A$
On Drain Current	$I_{DS} (\text{ON})$		12.0 3.0		mA	$V_{GS} = + 9.7V$ $V_{GS} = + 4.2V$ $V_{DS} = + 5V$
Forward Transconductance	G_{FS}		1.4		mmho	$V_{GS} = +4.2V$ $V_{DS} = + 9.2V$
Transconductance Mismatch	ΔG_{FS}		1.8		%	
Output Conductance	G_{OS}		68		μmho	$V_{GS} = +4.2V$ $V_{DS} = +9.2V$
Drain Source On Resistance	$R_{DS (\text{ON})}$		500		Ω	$V_{DS} = 0.1V$ $V_{GS} = +4.2V$
Drain Source On Resistance Mismatch	$\Delta R_{DS (\text{ON})}$		0.5		%	
Drain Source Breakdown Voltage	BV_{DSX}		10		V	$I_{DS} = 1.0\mu A$ $V_{GS} = -0.8V$
Drain Source Leakage Current ¹	$I_{DS (\text{OFF})}$		10	100 4	pA nA	$V_{GS} = -0.8V$ $V_{DS} = 10V, T_A = 125^\circ C$
Gate Leakage Current ¹	I_{GSS}		3	30 1	pA nA	$V_{DS} = 0V$ $V_{GS} = 10V$ $T_A = 125^\circ C$
Input Capacitance	C_{ISS}		2.5		pF	
Transfer Reverse Capacitance	C_{RSS}		0.1		pF	
Turn-on Delay Time	t_{on}		10		ns	$V^+ = 5V$ $R_L = 5K\Omega$
Turn-off Delay Time	t_{off}		10		ns	$V^+ = 5V$ $R_L = 5K\Omega$
Crosstalk			60		dB	$f = 100KHz$

Notes: ¹ Consists of junction leakage currents